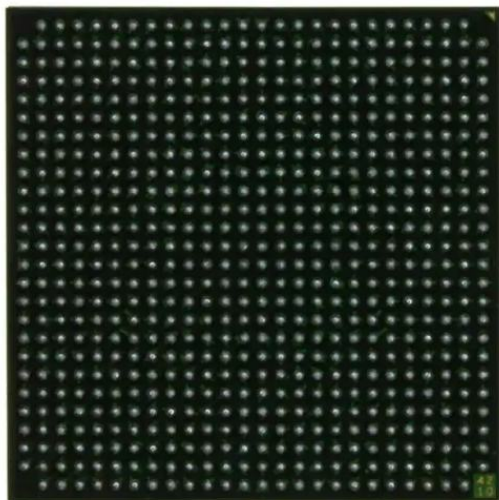




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

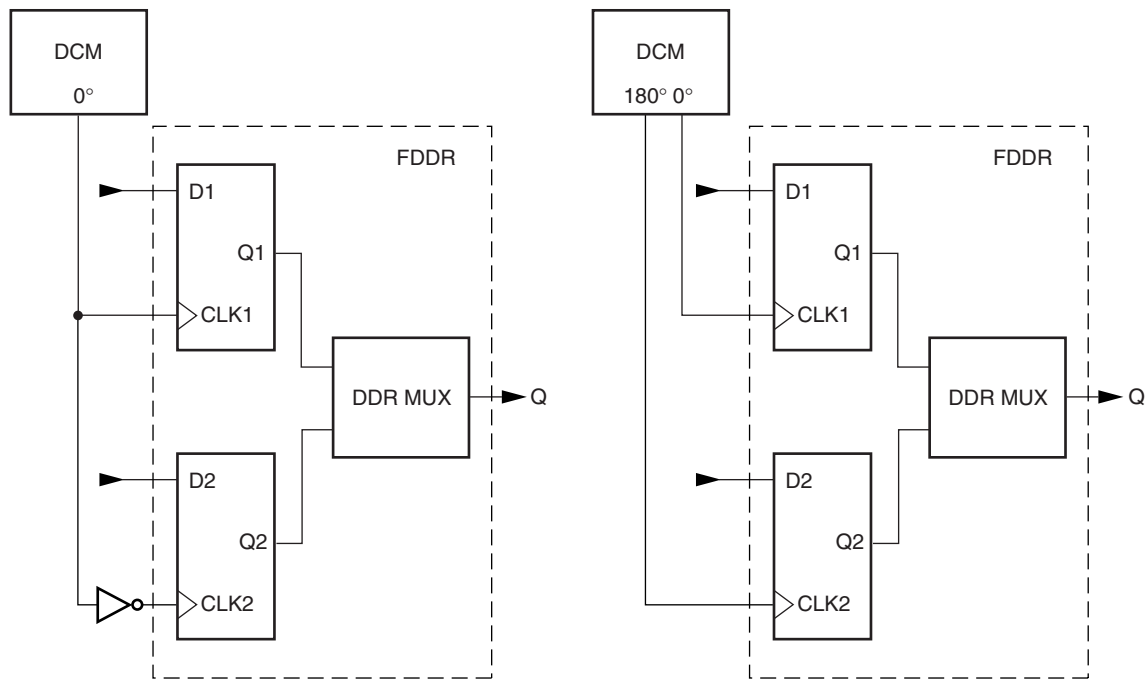
Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	1232
Number of Logic Elements/Cells	11088
Total RAM Bits	811008
Number of I/O	396
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA, FCBGA
Supplier Device Package	672-FCBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp7-5ffg672c



DS083-2_26_122001

Figure 20: Double Data Rate Registers

This DDR mechanism can be used to mirror a copy of the clock on the output. This is useful for propagating a clock along the data that has an identical delay. It is also useful for multiple clock generation, where there is a unique clock driver for every clock load. Virtex-II Pro devices can produce many copies of a clock with very little skew.

Each group of two registers has a clock enable signal (ICE for the input registers, OCE for the output registers, and TCE for the 3-state registers). The clock enable signals are active High by default. If left unconnected, the clock enable for that storage element defaults to the active state.

Each IOB block has common synchronous or asynchronous set and reset (SR and REV signals). Two neighboring IOBs have a shared routing resource connecting the ICLK and OTCLK pins on pairs of IOBs. If two adjacent IOBs using DDR registers do not share the same clock signals on their clock pins (ICLK1, ICLK2, OTCLK1, and OTCLK2), one of the clock signals will be unroutable.

The IOB pairing is identical to the LVDS IOB pairs. Hence, the package pin-out table can also be used for pin assignment to avoid conflict.

SR forces the storage element into the state specified by the SRHIGH or SRLOW attribute. SRHIGH forces a logic 1. SRLOW forces a logic "0". When SR is used, a second input

(REV) forces the storage element into the opposite state. The reset condition predominates over the set condition. The initial state after configuration or global initialization state is defined by a separate INIT0 and INIT1 attribute. By default, the SRLOW attribute forces INIT0, and the SRHIGH attribute forces INIT1.

For each storage element, the SRHIGH, SRLOW, INIT0, and INIT1 attributes are independent. Synchronous or asynchronous set / reset is consistent in an IOB block.

All the control signals have independent polarity. Any inverter placed on a control input is automatically absorbed.

Each register or latch, independent of all other registers or latches, can be configured as follows:

- No set or reset
- Synchronous set
- Synchronous reset
- Synchronous set and reset
- Asynchronous set (preset)
- Asynchronous reset (clear)
- Asynchronous set and reset (preset and clear)

The synchronous reset overrides a set, and an asynchronous clear overrides a preset.

Refer to [Figure 21](#).

Multiplexers

Virtex-II Pro function generators and associated multiplexers can implement the following:

- 4:1 multiplexer in one slice
- 8:1 multiplexer in two slices
- 16:1 multiplexer in one CLB element (4 slices)
- 32:1 multiplexer in two CLB elements (8 slices)

Each Virtex-II Pro slice has one MUXF5 multiplexer and one MUXFX multiplexer. The MUXFX multiplexer implements the MUXF6, MUXF7, or MUXF8, as shown in **Figure 41**. Each CLB element has two MUXF6 multiplexers, one MUXF7 multiplexer and one MUXF8 multiplexer. Examples of multiplexers are shown in the *Virtex-II Pro Platform FPGA User Guide*. Any LUT can implement a 2:1 multiplexer.

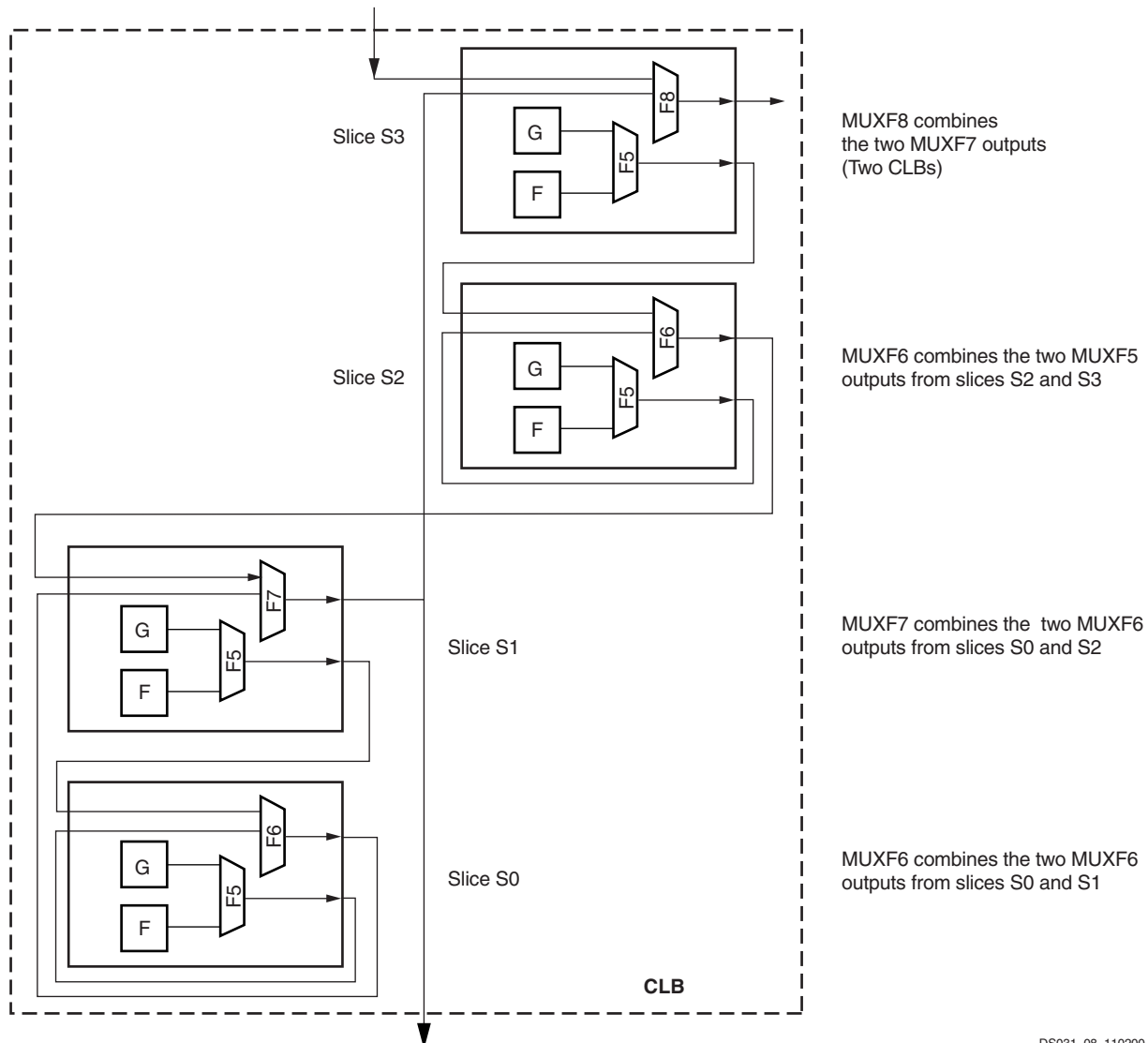


Figure 41: MUXF5 and MUXFX multiplexers

DS031_08_110200

Fast Lookahead Carry Logic

Dedicated carry logic provides fast arithmetic addition and subtraction. The Virtex-II Pro CLB has two separate carry chains, as shown in the **Figure 42**.

The height of the carry chains is two bits per slice. The carry chain in the Virtex-II Pro device is running upward. The dedicated carry path and carry multiplexer (MUXCY) can also

be used to cascade function generators for implementing wide logic functions.

Arithmetic Logic

The arithmetic logic includes an XOR gate that allows a 2-bit full adder to be implemented within a slice. In addition, a dedicated AND (MULT_AND) gate (shown in **Figure 34**) improves the efficiency of multiplier implementation.

Date	Version	Revision
03/24/03	2.5.1	Table 10: Corrected I/O standard names SSTL18_I and SSTL18_II to SSTL18_I_DCI and SSTL18_II_DCI respectively. Figure 61, text below: Corrected wording of criteria for clock switching.
05/27/03	2.6	- Removed Compatible Output Standards and Compatible Input Standards tables. - Added new Table 12, Summary of Voltage Supply Requirements for All Input and Output Standards. This table replaces deleted I/O standards tables. - Corrected sentence in section Input/Output Individual Options, page 27, to read "The optional weak-keeper circuit is connected to each <i>user I/O pad</i>." - Added section Rules for Combining I/O Standards in the Same Bank, page 29.
06/02/03	2.7	- Added four Differential Termination I/O standards to Table 9 and Table 12. - Added section On-Chip Differential Termination and Figure 31, page 34.
08/25/03	2.7.1	Added footnote referring to XAPP659 to 3.3V I/O callouts in Table 8 and Table 12.
09/10/03	2.8	Section Configuration, page 56: Added text indicating that the mode pins M0-M2 must be held to a constant DC level during and after configuration.
10/14/03	2.9	- Deleted section Functional Description: RocketIO Multi-Gigabit Transceiver (MGT), page 10. Added section Local Clocking, page 51. - Sections Slave-Serial Mode and Master-Serial Mode, page 56: Changed "rising" to "falling" edge with respect to DOUT. Table 8, page 24 and Table 10, page 25: Corrected Input V_{REF} for HSTL_III-IV_18 from 1.08V to 1.1V.
12/10/03	3.0	XC2VP2 through XC2VP70 speed grades -5, -6, and -7, and XC2VP100 speed grades -5 and -6, are released to Production status.
02/19/04	3.1	Section BUFGMUX, page 50: Corrected the definition of the "presently selected clock" to be I0 or I1. Corrected signal names in Figure 61 and associated text from CLK0 and CLK1 to I0 and I1.
03/09/04	3.1.1	Recompiled for backward compatibility with Acrobat 4 and above. No content changes.
04/22/04	3.2	Section Clock De-skew, page 52: Removed reference to CLK2X as an option for DCM clock feedback.
06/30/04	4.0	Merged in DS110-2 (Module 2 of Virtex-II Pro X data sheet). Separate RocketIO and RocketIO X sections created.
11/17/04	4.1	Figure 11, page 12: Corrected figure by removing coupling capacitors from input. - Section Rules for Combining I/O Standards in the Same Bank, page 29: Corrected I/O standard in the first example from LVDS_25_DCI to LVDS_25.
03/01/05	4.2	- Reassigned heading hierarchies for better agreement with content. Table 7: Corrected VCCAUTX and VCCAUXRX to AVCCAUTX and AVCCAUXRX respectively. Table 9: Corrected V_{OD} (output voltage) range for LVDSEXT_25. Table 25: Corrected SelectRAM+ memory available for XC2VPX70 device. Table 33: Updated configuration default bitstream lengths.
06/20/05	4.3	<i>No changes in Module 2 for this revision.</i>
09/15/05	4.4	Table 1: Deleted SONET OC-192 protocol. Table 3: Deleted RocketIO X primitives for SONET OC-192, 10 Gbit Ethernet, and Xilinx 10G (Aurora) protocols. - Changed all instances of 10.3125 Gb/s to 6.25 Gb/s. Table 7: Changed RocketIO X VCCAUXRX from 1.5V globally to 1.5V for 8B/10B encoding, 1.8V for all other encoding protocols.

IOB Output Switching Characteristics

Output delays terminating at a pad are specified for LVCMOS25 with 12 mA drive and fast slew rate. For other standards, adjust the delays with the values shown in [IOB Output Switching Characteristics Standard Adjustments](#).

Table 37: IOB Output Switching Characteristics

		Speed Grade			
Description	Symbol	-7	-6	-5	Units
Propagation Delays					
O input to Pad	T _{IOOP}	1.58	1.68	1.85	ns, max
O input to Pad via transparent latch	T _{IOOLP}	1.65	1.82	1.99	ns, max
3-State Delays					
T input to Pad high-impedance ⁽²⁾	T _{IOTHZ}	1.23	1.35	1.51	ns, max
T input to valid data on Pad	T _{IOTP}	1.51	1.63	1.78	ns, max
T input to Pad high-impedance via transparent latch ⁽²⁾	T _{IOTLPHZ}	1.08	1.22	1.36	ns, max
T input to valid data on Pad via transparent latch	T _{IOTLPON}	1.56	1.69	1.85	ns, max
GTS to Pad high-impedance ⁽²⁾	T _{GTS}	4.11	4.73	5.20	ns, max
Sequential Delays					
Clock CLK to Pad	T _{IOCKP}	1.59	1.76	1.93	ns, max
Clock CLK to Pad high-impedance (synchronous) ⁽²⁾	T _{IOCKHZ}	1.39	1.55	1.73	ns, max
Clock CLK to valid data on Pad (synchronous)	T _{IOCKON}	1.67	1.82	2.00	ns, max
Setup and Hold Times Before/After Clock CLK					
O input	T _{IOOCK} /T _{IOCKO}	0.23/ 0.12	0.26/ 0.14	0.29/ 0.15	ns, min
OCE input	T _{IOOCECK} /T _{IOCKOCE}	0.39/ 0.01	0.44/ 0.01	0.49/ 0.01	ns, min
SR input (OFF)	T _{IOSRCKO} /T _{IOCKOSR}	0.52/ 0.00	0.57/ 0.00	0.75/ 0.00	ns, min
3-State Setup Times, T input	T _{IOTCK} /T _{IOCKT}	0.23/ 0.12	0.26/ 0.14	0.29/ 0.15	ns, min
3-State Setup Times, TCE input	T _{IOTCECK} /T _{IOCKTCE}	0.39/ 0.01	0.44/ 0.01	0.49/ 0.01	ns, min
3-State Setup Times, SR input (TFF)	T _{IOSRCKT} /T _{IOCKTSR}	0.52/ 0.00	0.57/ 0.00	0.75/ 0.00	ns, min
Set/Reset Delays					
Minimum Pulse Width, SR inputs (asynchronous)	T _{RPW}	0.37	0.40	0.45	ns, min
SR input to Pad (asynchronous)	T _{IOSRP}	2.33	2.56	2.83	ns, max
SR input to Pad high-impedance (asynchronous) ⁽²⁾	T _{IOSRHZ}	1.97	2.16	2.41	ns, max
SR input to valid data on Pad (asynchronous)	T _{IOSRON}	2.24	2.44	2.69	ns, max
GSR to Pad	T _{IOGSRQ}	5.87	6.75	7.43	ns, max

Notes:

1. A Zero "0" Hold Time listing indicates no hold time or a negative hold time. Negative values can not be guaranteed "best-case", but if a "0" is listed, there is no positive hold time.
2. The 3-state turn-off delays should not be adjusted.

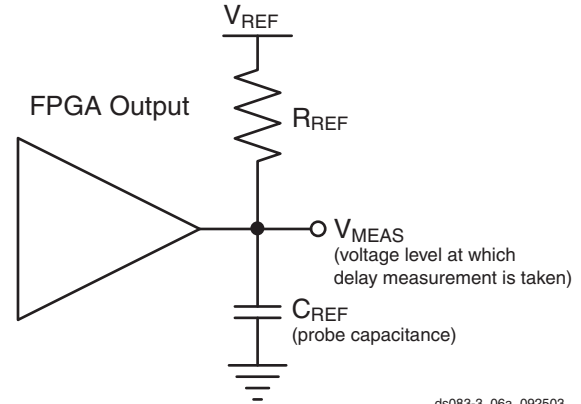
Output Delay Measurements

Output delays are measured using a Tektronix P6245 TDS500/600 probe (< 1 pF) across approximately 4" of FR4 microstrip trace. Standard termination was used for all testing. (See [Virtex-II Pro Platform FPGA User Guide](#) for details.) The propagation delay of the 4" trace is characterized separately and subtracted from the final measurement, and is therefore not included in the generalized test setup shown in [Figure 6](#).

Measurements and test conditions are reflected in the IBIS models except where the IBIS format precludes it. (IBIS models can be found on the web at http://support.xilinx.com/support/sw_ibis.htm.) Parameters V_{REF} , R_{REF} , C_{REF} , and V_{MEAS} fully describe the test conditions for each I/O standard. The most accurate prediction of propagation delay in any given application can be obtained through IBIS simulation, using the following method:

1. Simulate the output driver of choice into the generalized test setup, using values from [Table 40](#).
2. Record the time to V_{MEAS} .
3. Simulate the output driver of choice into the actual PCB trace and load, using the appropriate IBIS model or capacitance value to represent the load.

4. Record the time to V_{MEAS} .
5. Compare the results of steps 2 and 4. The increase or decrease in delay should be added to or subtracted from the I/O Output Standard Adjustment value ([Table 38](#)) to yield the actual worst-case propagation delay (clock-to-input) of the PCB trace.



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Figure 6: Generalized Test Setup

Table 40: Output Delay Measurement Methodology

Description	IOSTANDARD Attribute	R_{REF} (Ω)	$C_{REF}^{(1)}$ (pF)	V_{MEAS} (V)	V_{REF} (V)
LVTTTL (Low-Voltage Transistor-Transistor Logic)	LVTTTL (all)	1M	0	1.65	0
LVC MOS (Low-Voltage CMOS), 3.3V	LVC MOS33	1M	0	1.65	0
LVC MOS, 2.5V	LVC MOS25	1M	0	1.25	0
LVC MOS, 1.8V	LVC MOS18	1M	0	0.9	0
LVC MOS, 1.5V	LVC MOS15	1M	0	0.75	0
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3 (rising edge)	25	$10^{(2)}$	0.94	0
	PCI33_3 (falling edge)	25	$10^{(2)}$	2.03	3.3
PCI, 66 MHz, 3.3V	PCI66_3 (rising edge)	25	$10^{(2)}$	0.94	0
	PCI66_3 (falling edge)	25	$10^{(2)}$	2.03	3.3
PCI-X, 133 MHz, 3.3V	PCIX (rising edge)	25	$10^{(3)}$	0.94	0
	PCIX (falling edge)	25	$10^{(3)}$	2.03	3.3
GTL (Gunning Transceiver Logic)	GTL	25	0	0.8	1.2
GTL Plus	GTLP	25	0	1.0	1.5
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	50	0	V_{REF}	0.75
HSTL, Class II	HSTL_II	25	0	V_{REF}	0.75
HSTL, Class III	HSTL_III	50	0	0.9	1.5
HSTL, Class IV	HSTL_IV	25	0	0.9	1.5
HSTL, Class I, 1.8V	HSTL_I_18	50	0	V_{REF}	0.9
HSTL, Class II, 1.8V	HSTL_II_18	25	0	V_{REF}	0.9
HSTL, Class III, 1.8V	HSTL_III_18	50	0	1.1	1.8
HSTL, Class IV, 1.8V	HSTL_IV_18	25	0	1.1	1.8

Table 5: FG256/FGG256 — XC2VP2 and XC2VP4

Bank	Pin Description	Pin Number
5	IO_L06N_5/VRP_5	P5
5	IO_L06P_5/VRN_5	N5
5	IO_L03N_5/D4	T3
5	IO_L03P_5/D5	T2
5	IO_L02N_5/D6	P4
5	IO_L02P_5/D7	R3
5	IO_L01N_5/RDWR_B	P3
5	IO_L01P_5/CS_B	P2
6	IO_L01P_6/VRN_6	M3
6	IO_L01N_6/VRP_6	M2
6	IO_L02P_6	N1
6	IO_L02N_6	M1
6	IO_L03P_6	M4
6	IO_L03N_6/VREF_6	L5
6	IO_L05P_6	L4
6	IO_L05N_6	L3
6	IO_L06P_6	L2
6	IO_L06N_6	L1
6	IO_L85P_6	K4
6	IO_L85N_6	K3
6	IO_L87P_6	K2
6	IO_L87N_6/VREF_6	K1
6	IO_L89P_6	K5
6	IO_L89N_6	J4
6	IO_L90P_6	J3
6	IO_L90N_6	J2
7	IO_L90P_7	J1
7	IO_L90N_7	H1
7	IO_L88P_7	H2
7	IO_L88N_7/VREF_7	H3
7	IO_L86P_7	H4
7	IO_L86N_7	G5
7	IO_L85P_7	G1

Table 5: FG256/FGG256 — XC2VP2 and XC2VP4

Bank	Pin Description	Pin Number
N/A	AVCCAUXRX7	B13
N/A	AVCCAUXRX18	R13
N/A	VTRXPAD18	R12
N/A	RXNPAD18	T13
N/A	RXPPAD18	T12
N/A	GNDA18	P11
N/A	TXPPAD18	T11
N/A	TXNPAD18	T10
N/A	VTTXPAD18	R10
N/A	AVCCAUXTX18	R11
N/A	AVCCAUXRX19	R7
N/A	VTRXPAD19	R6
N/A	RXNPAD19	T7
N/A	RXPPAD19	T6
N/A	GNDA19	P6
N/A	TXPPAD19	T5
N/A	TXNPAD19	T4
N/A	VTTXPAD19	R4
N/A	AVCCAUXTX19	R5
N/A	VCCINT	N4
N/A	VCCINT	N13
N/A	VCCINT	M5
N/A	VCCINT	M12
N/A	VCCINT	E5
N/A	VCCINT	E12
N/A	VCCINT	D4
N/A	VCCINT	D13
N/A	VCCAUX	R16
N/A	VCCAUX	R1
N/A	VCCAUX	B16
N/A	VCCAUX	B1
N/A	GND	T16
N/A	GND	T1
N/A	GND	R2

FF672 Flip-Chip Fine-Pitch BGA Package

As shown in [Table 8](#), XC2VP2, XC2VP4, and XC2VP7 Virtex-II Pro devices are available in the FF672 flip-chip fine-pitch BGA package. Pins in each of these devices are the same, except for differences shown in the "No Connects" column. Following this table are the [FF672 Flip-Chip Fine-Pitch BGA Package Specifications \(1.00mm pitch\)](#).

Table 8: FF672 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
0	IO_L01N_0/VRP_0	B24			
0	IO_L01P_0/VRN_0	A24			
0	IO_L02N_0	D21			
0	IO_L02P_0	C21			
0	IO_L03N_0	E20			
0	IO_L03P_0/VREF_0	D20			
0	IO_L05_0/No_Pair	F19			
0	IO_L06N_0	E19			
0	IO_L06P_0	E18			
0	IO_L07N_0	D19			
0	IO_L07P_0	C19			
0	IO_L08N_0	B19			
0	IO_L08P_0	A19			
0	IO_L09N_0	G18			
0	IO_L09P_0/VREF_0	F18			
0	IO_L37N_0	D18	NC	NC	
0	IO_L37P_0	C18	NC	NC	
0	IO_L38N_0	G17	NC	NC	
0	IO_L38P_0	H16	NC	NC	
0	IO_L39N_0	F17	NC	NC	
0	IO_L39P_0	F16	NC	NC	
0	IO_L43N_0	E17	NC	NC	
0	IO_L43P_0	D17	NC	NC	
0	IO_L44N_0	G16	NC	NC	
0	IO_L44P_0	G15	NC	NC	
0	IO_L45N_0	E16	NC	NC	
0	IO_L45P_0/VREF_0	D16	NC	NC	
0	IO_L67N_0	F15			
0	IO_L67P_0	E15			
0	IO_L68N_0	D15			
0	IO_L68P_0	C15			
0	IO_L69N_0	H15			
0	IO_L69P_0/VREF_0	H14			

FF1152 Flip-Chip Fine-Pitch BGA Package

As shown in [Table 10](#), XC2VP20, XC2VP30, XC2VP40, and XC2VP50 Virtex-II Pro devices are available in the FF1152 flip-chip fine-pitch BGA package. Pins in each of these devices are the same, except for the differences shown in the No Connect column. Following this table are the [FF1152 Flip-Chip Fine-Pitch BGA Package Specifications \(1.00mm pitch\)](#).

Table 10: FF1152 — XC2VP20, XC2VP30, XC2VP40, and XC2VP50

Bank	Pin Description	Pin Number	No Connects			
			XC2VP20	XC2VP30	XC2VP40	XC2VP50
0	IO_L01N_0/VRP_0	E29				
0	IO_L01P_0/VRN_0	E28				
0	IO_L02N_0	H26				
0	IO_L02P_0	G26				
0	IO_L03N_0	H25				
0	IO_L03P_0/VREF_0	G25				
0	IO_L05_0/No_Pair	J25				
0	IO_L06N_0	K24				
0	IO_L06P_0	J24				
0	IO_L07N_0	F26				
0	IO_L07P_0	E26				
0	IO_L08N_0	D30				
0	IO_L08P_0	D29				
0	IO_L09N_0	K23				
0	IO_L09P_0/VREF_0	J23				
0	IO_L19N_0	F24	NC	NC		
0	IO_L19P_0	E24	NC	NC		
0	IO_L20N_0	D28	NC	NC		
0	IO_L20P_0	C28	NC	NC		
0	IO_L21N_0	H24	NC	NC		
0	IO_L21P_0	G24	NC	NC		
0	IO_L25N_0	G23	NC	NC		
0	IO_L25P_0	F23	NC	NC		
0	IO_L26N_0	E27	NC	NC		
0	IO_L26P_0	D27	NC	NC		
0	IO_L27N_0	K22	NC	NC		
0	IO_L27P_0/VREF_0	J22	NC	NC		
0	IO_L37N_0	H22				
0	IO_L37P_0	G22				
0	IO_L38N_0	D26				
0	IO_L38P_0	C26				
0	IO_L39N_0	K21				
0	IO_L39P_0	J21				
0	IO_L43N_0	F22				

FF1148 Flip-Chip Fine-Pitch BGA Package

As shown in [Table 11](#), XC2VP40 and XC2VP50 Virtex-II Pro devices are available in the FF1148 flip-chip fine-pitch BGA package. Pins in each of these devices are the same, except for the differences shown in the No Connect column. Following this table are the [FF1148 Flip-Chip Fine-Pitch BGA Package Specifications \(1.00mm pitch\)](#).

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
0	IO_L01N_0/VRP_0	E25		
0	IO_L01P_0/VRN_0	F25		
0	IO_L02N_0	J24		
0	IO_L02P_0	K24		
0	IO_L03N_0	C25		
0	IO_L03P_0/VREF_0	D25		
0	IO_L05_0/No_Pair	G25		
0	IO_L06N_0	A25		
0	IO_L06P_0	B25		
0	IO_L07N_0	G24		
0	IO_L07P_0	G23		
0	IO_L08N_0	H23		
0	IO_L08P_0	H22		
0	IO_L09N_0	E24		
0	IO_L09P_0/VREF_0	F24		
0	IO_L19N_0	C24		
0	IO_L19P_0	C23		
0	IO_L20N_0	J23		
0	IO_L20P_0	K23		
0	IO_L21N_0	A24		
0	IO_L21P_0	B24		
0	IO_L25N_0	E23		
0	IO_L25P_0	F23		
0	IO_L26N_0	K22		
0	IO_L26P_0	L22		
0	IO_L27N_0	D23		
0	IO_L27P_0/VREF_0	D22		
0	IO_L37N_0	A23		
0	IO_L37P_0	B23		
0	IO_L38N_0	J21		
0	IO_L38P_0	J20		
0	IO_L39N_0	F22		
0	IO_L39P_0	G22		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
6	IO_L25N_6	AH29		
6	IO_L26P_6	AE28		
6	IO_L26N_6	AD28		
6	IO_L27P_6	AG32		
6	IO_L27N_6/VREF_6	AG33		
6	IO_L28P_6	AH32		
6	IO_L28N_6	AG31		
6	IO_L29P_6	AE26		
6	IO_L29N_6	AD26		
6	IO_L30P_6	AG29		
6	IO_L30N_6	AG30		
6	IO_L31P_6	AF32		
6	IO_L31N_6	AF33		
6	IO_L32P_6	AC26		
6	IO_L32N_6	AC27		
6	IO_L33P_6	AF28		
6	IO_L33N_6/VREF_6	AF29		
6	IO_L34P_6	AE33		
6	IO_L34N_6	AE34		
6	IO_L35P_6	AD25		
6	IO_L35N_6	AC25		
6	IO_L36P_6	AF31		
6	IO_L36N_6	AE31		
6	IO_L37P_6	AE29		
6	IO_L37N_6	AE30		
6	IO_L38P_6	AC28		
6	IO_L38N_6	AB27		
6	IO_L39P_6	AD33		
6	IO_L39N_6/VREF_6	AD34		
6	IO_L40P_6	AE32		
6	IO_L40N_6	AD32		
6	IO_L41P_6	AB24		
6	IO_L41N_6	AB25		
6	IO_L42P_6	AD29		
6	IO_L42N_6	AD30		
6	IO_L43P_6	AC33		
6	IO_L43N_6	AC34		
6	IO_L44P_6	AA27		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
0	IO_L34P_0	E27	NC	
0	IO_L35N_0	L26	NC	
0	IO_L35P_0	L25	NC	
0	IO_L36N_0	G26	NC	
0	IO_L36P_0/VREF_0	H26	NC	
0	IO_L37N_0	E26		
0	IO_L37P_0	F26		
0	IO_L38N_0	K25		
0	IO_L38P_0	K24		
0	IO_L39N_0	C26		
0	IO_L39P_0	D26		
0	IO_L43N_0	H25		
0	IO_L43P_0	J25		
0	IO_L44N_0	M25		
0	IO_L44P_0	M24		
0	IO_L45N_0	F25		
0	IO_L45P_0/VREF_0	G25		
0	IO_L46N_0	C25		
0	IO_L46P_0	D25		
0	IO_L47N_0	L23		
0	IO_L47P_0	M22		
0	IO_L48N_0	H24		
0	IO_L48P_0	J24		
0	IO_L49N_0	E25		
0	IO_L49P_0	E24		
0	IO_L50_0/No_Pair	N23		
0	IO_L53_0/No_Pair	M23		
0	IO_L54N_0	H23		
0	IO_L54P_0	J23		
0	IO_L55N_0	F24		
0	IO_L55P_0	G23		
0	IO_L56N_0	K22		
0	IO_L56P_0	L22		
0	IO_L57N_0	C23		
0	IO_L57P_0/VREF_0	D23		
0	IO_L58N_0	H22		
0	IO_L58P_0	J22		
0	IO_L59N_0	N22		

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
N/A	TXNPAD11	A7		
N/A	TXPPAD11	A6		
N/A	GND A11	C6		
N/A	RXPPAD11	A5		
N/A	RXNPAD11	A4		
N/A	VTRXPAD11	B5		
N/A	AVCCAUXRX11	B4		
N/A	AVCCAUXRX14	AV4		
N/A	VTRXPAD14	AV5		
N/A	RXNPAD14	AW4		
N/A	RXPPAD14	AW5		
N/A	GND A14	AU6		
N/A	TXPPAD14	AW6		
N/A	TXNPAD14	AW7		
N/A	VTTXPAD14	AV7		
N/A	AVCCAUXTX14	AV6		
N/A	AVCCAUXRX16	AV8		
N/A	VTRXPAD16	AV9		
N/A	RXNPAD16	AW8		
N/A	RXPPAD16	AW9		
N/A	GND A16	AU9		
N/A	TXPPAD16	AW10		
N/A	TXNPAD16	AW11		
N/A	VTTXPAD16	AV11		
N/A	AVCCAUXTX16	AV10		
N/A	AVCCAUXRX17	AV12		
N/A	VTRXPAD17	AV13		
N/A	RXNPAD17	AW12		
N/A	RXPPAD17	AW13		
N/A	GND A17	AU13		
N/A	TXPPAD17	AW14		
N/A	TXNPAD17	AW15		
N/A	VTTXPAD17	AV15		
N/A	AVCCAUXTX17	AV14		
N/A	AVCCAUXRX18	AV16		
N/A	VTRXPAD18	AV17		
N/A	RXNPAD18	AW16		
N/A	RXPPAD18	AW17		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
3	IO_L35N_3		AH11		
3	IO_L35P_3		AH12		
3	IO_L34N_3		AH5		
3	IO_L34P_3		AH6		
3	IO_L33N_3/VREF_3		AH9		
3	IO_L33P_3		AH10		
3	IO_L32N_3		AJ11		
3	IO_L32P_3		AJ12		
3	IO_L31N_3		AJ1		
3	IO_L31P_3		AJ2		
3	IO_L30N_3		AJ5		
3	IO_L30P_3		AJ6		
3	IO_L29N_3		AJ9		
3	IO_L29P_3		AJ10		
3	IO_L28N_3		AJ7		
3	IO_L28P_3		AJ8		
3	IO_L27N_3/VREF_3		AK1		
3	IO_L27P_3		AK2		
3	IO_L26N_3		AK11		
3	IO_L26P_3		AK12		
3	IO_L25N_3		AK3		
3	IO_L25P_3		AK4		
3	IO_L24N_3		AK5		
3	IO_L24P_3		AK6		
3	IO_L23N_3		AK9		
3	IO_L23P_3		AK10		
3	IO_L22N_3		AK7		
3	IO_L22P_3		AK8		
3	IO_L21N_3/VREF_3		AL2		
3	IO_L21P_3		AL3		
3	IO_L20N_3		AL11		
3	IO_L20P_3		AL12		
3	IO_L19N_3		AL4		
3	IO_L19P_3		AL5		
3	IO_L18N_3		AL7		
3	IO_L18P_3		AL8		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
5	IO_L64N_5		AU24		
5	IO_L64P_5		AV24		
5	IO_L60N_5		AR24		
5	IO_L60P_5		AT24		
5	IO_L59N_5		AN24		
5	IO_L59P_5		AP24		
5	IO_L58N_5		AL24		
5	IO_L58P_5		AM24		
5	IO_L57N_5/VREF_5		AY26		
5	IO_L57P_5		AY25		
5	IO_L56N_5		AV25		
5	IO_L56P_5		AV26		
5	IO_L55N_5		AR25		
5	IO_L55P_5		AT25		
5	IO_L54N_5		AM25		
5	IO_L54P_5		AN25		
5	IO_L53_5/No_Pair		AW26		
5	IO_L50_5/No_Pair		AW27		
5	IO_L49N_5		AT26		
5	IO_L49P_5		AU26		
5	IO_L48N_5		AP26		
5	IO_L48P_5		AR26		
5	IO_L47N_5		AN26		
5	IO_L47P_5		AM26		
5	IO_L46N_5		AL26		
5	IO_L46P_5		AL25		
5	IO_L45N_5/VREF_5		AU27		
5	IO_L45P_5		AV27		
5	IO_L44N_5		AT27		
5	IO_L44P_5		AR27		
5	IO_L43N_5		AN27		
5	IO_L43P_5		AP27		
5	IO_L39N_5		AL27		
5	IO_L39P_5		AM27		
5	IO_L38N_5		AY28		
5	IO_L38P_5		AY29		

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
1	IO_L87N_1/VREF_1	C15	
1	IO_L87P_1	C16	
1	IO_L86N_1	K15	
1	IO_L86P_1	J15	
1	IO_L85N_1	F15	
1	IO_L85P_1	E15	
1	IO_L84N_1	G15	
1	IO_L84P_1	G16	
1	IO_L83_1/No_Pair	M15	
1	IO_L80_1/No_Pair	L15	
1	IO_L79N_1	B14	
1	IO_L79P_1	A14	
1	IO_L78N_1	C14	
1	IO_L78P_1	D15	
1	IO_L77N_1	K14	
1	IO_L77P_1	J14	
1	IO_L76N_1	F14	
1	IO_L76P_1	E14	
1	IO_L36N_1/VREF_1	G14	
1	IO_L36P_1	H15	
1	IO_L35N_1	M14	
1	IO_L35P_1	L14	
1	IO_L34N_1	C13	
1	IO_L34P_1	B13	
1	IO_L30N_1	G13	
1	IO_L30P_1	F13	
1	IO_L29N_1	L13	
1	IO_L29P_1	K13	
1	IO_L28N_1	C12	
1	IO_L28P_1	B12	
1	IO_L27N_1/VREF_1	D12	
1	IO_L27P_1	D13	
1	IO_L26N_1	J12	
1	IO_L26P_1	H12	
1	IO_L25N_1	F12	
1	IO_L25P_1	E12	
1	IO_L21N_1	G12	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
1	IO_L21P_1	H13	
1	IO_L20N_1	L12	
1	IO_L20P_1	K12	
1	IO_L19N_1	B11	
1	IO_L19P_1	A11	
1	IO_L09N_1/VREF_1	E11	
1	IO_L09P_1	D11	
1	IO_L08N_1	J11	
1	IO_L08P_1	H11	
1	IO_L07N_1	G11	
1	IO_L07P_1	F11	
1	IO_L06N_1	B10	
1	IO_L06P_1	A10	
1	IO_L05_1/No_Pair	G10	
1	IO_L03N_1/VREF_1	C10	
1	IO_L03P_1	C11	
1	IO_L02N_1	L11	
1	IO_L02P_1	K11	
1	IO_L01N_1/VRP_1	F10	
1	IO_L01P_1/VRN_1	E10	
2	IO_L01N_2/VRP_2	B8	
2	IO_L01P_2/VRN_2	A8	
2	IO_L02N_2	C9	
2	IO_L02P_2	B9	
2	IO_L03N_2	B7	
2	IO_L03P_2	A7	
2	IO_L04N_2/VREF_2	B6	
2	IO_L04P_2	A6	
2	IO_L05N_2	D8	
2	IO_L05P_2	D9	
2	IO_L06N_2	B4	
2	IO_L06P_2	A4	
2	IO_L73N_2	C7	
2	IO_L73P_2	C8	
2	IO_L74N_2	G9	
2	IO_L74P_2	F9	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
2	IO_L22N_2/VREF_2	L4	
2	IO_L22P_2	L5	
2	IO_L23N_2	T8	
2	IO_L23P_2	T9	
2	IO_L24N_2	L3	
2	IO_L24P_2	K3	
2	IO_L25N_2	L1	
2	IO_L25P_2	L2	
2	IO_L26N_2	U12	
2	IO_L26P_2	V12	
2	IO_L27N_2	M7	
2	IO_L27P_2	L6	
2	IO_L28N_2/VREF_2	M5	
2	IO_L28P_2	M6	
2	IO_L29N_2	U10	
2	IO_L29P_2	U11	
2	IO_L30N_2	M3	
2	IO_L30P_2	M4	
2	IO_L31N_2	N6	
2	IO_L31P_2	N7	
2	IO_L32N_2	U7	
2	IO_L32P_2	U8	
2	IO_L33N_2	N3	
2	IO_L33P_2	N4	
2	IO_L34N_2/VREF_2	N2	
2	IO_L34P_2	M2	
2	IO_L35N_2	V10	
2	IO_L35P_2	V11	
2	IO_L36N_2	P6	
2	IO_L36P_2	P7	
2	IO_L37N_2	P1	
2	IO_L37P_2	P2	
2	IO_L38N_2	V8	
2	IO_L38P_2	V9	
2	IO_L39N_2	R6	
2	IO_L39P_2	P5	
2	IO_L40N_2/VREF_2	R4	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
3	IO_L38P_3	AE9	
3	IO_L37N_3	AH3	
3	IO_L37P_3	AJ3	
3	IO_L36N_3	AJ1	
3	IO_L36P_3	AJ2	
3	IO_L35N_3	AE6	
3	IO_L35P_3	AE7	
3	IO_L34N_3	AK6	
3	IO_L34P_3	AK7	
3	IO_L33N_3/VREF_3	AK3	
3	IO_L33P_3	AK4	
3	IO_L32N_3	AE12	
3	IO_L32P_3	AF12	
3	IO_L31N_3	AL5	
3	IO_L31P_3	AL6	
3	IO_L30N_3	AL3	
3	IO_L30P_3	AL4	
3	IO_L29N_3	AF10	
3	IO_L29P_3	AF11	
3	IO_L28N_3	AK2	
3	IO_L28P_3	AL2	
3	IO_L27N_3/VREF_3	AL7	
3	IO_L27P_3	AM6	
3	IO_L26N_3	AF7	
3	IO_L26P_3	AF8	
3	IO_L25N_3	AM4	
3	IO_L25P_3	AM5	
3	IO_L24N_3	AM1	
3	IO_L24P_3	AM2	
3	IO_L23N_3	AG10	
3	IO_L23P_3	AG11	
3	IO_L22N_3	AM7	
3	IO_L22P_3	AN7	
3	IO_L21N_3/VREF_3	AN5	
3	IO_L21P_3	AN6	
3	IO_L20N_3	AG8	
3	IO_L20P_3	AG9	

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
3	IO_L19N_3	AM3	
3	IO_L19P_3	AN3	
3	IO_L18N_3	AN1	
3	IO_L18P_3	AN2	
3	IO_L17N_3	AG12	
3	IO_L17P_3	AH12	
3	IO_L16N_3	AP6	
3	IO_L16P_3	AP7	
3	IO_L15N_3/VREF_3	AP3	
3	IO_L15P_3	AP4	
3	IO_L14N_3	AH10	
3	IO_L14P_3	AH11	
3	IO_L13N_3	AR6	
3	IO_L13P_3	AR7	
3	IO_L12N_3	AR4	
3	IO_L12P_3	AR5	
3	IO_L11N_3	AH8	
3	IO_L11P_3	AH9	
3	IO_L10N_3	AR2	
3	IO_L10P_3	AR3	
3	IO_L09N_3/VREF_3	AP2	
3	IO_L09P_3	AR1	
3	IO_L08N_3	AJ10	
3	IO_L08P_3	AJ11	
3	IO_L07N_3	AT7	
3	IO_L07P_3	AT8	
3	IO_L72N_3	AT3	
3	IO_L72P_3	AT4	
3	IO_L71N_3	AJ12	
3	IO_L71P_3	AK12	
3	IO_L70N_3	AT1	
3	IO_L70P_3	AT2	
3	IO_L69N_3/VREF_3	AT6	
3	IO_L69P_3	AU6	
3	IO_L68N_3	AK10	
3	IO_L68P_3	AK11	
3	IO_L67N_3	AT5	